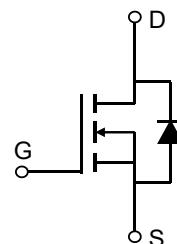


## Description

### Features

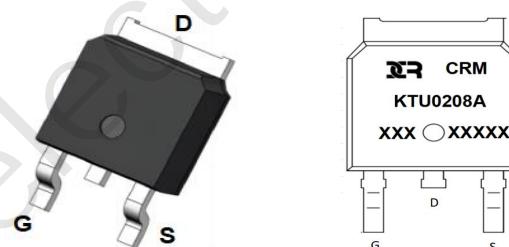
- 20V, 50A
- $R_{DS(ON)}$  Typ = 6mΩ @  $V_{GS}$  = 4.5V
- $R_{DS(ON)}$  Typ = 7.6mΩ @  $V_{GS}$  = 2.5V
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- 100% UIS TESTED!
- 100%  $\Delta V_{ds}$  TESTED!



Schematic Diagram

### Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

### Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTU0208A	CRMKTU0208A	TO-252-3L	TAPING	13"	2500	25000

### Absolute Maximum Ratings (@ $T_J$ = 25°C unless otherwise specified)

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-to-Source Voltage	20	V
$V_{GS}$	Gate-to-Source Voltage	$\pm 12$	V
$I_D$	Continuous Drain Current $T_C = 25^\circ\text{C}$	50	A
		$T_C = 100^\circ\text{C}$	A
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	200	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>	42.5	mJ
$P_D$	Power Dissipation $T_C = 25^\circ\text{C}$	33.2	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.7	°C/W
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 to 150	°C

**Electrical Characteristics ( $T_J = 25^\circ\text{C}$  unless otherwise specified)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	20	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 12\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.4	0.7	1.2	V
$R_{DS(\text{ON})}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 4.5\text{V}, I_D = 20\text{A}$	-	6.0	7.8	$\text{m}\Omega$
		$V_{GS} = 2.5\text{V}, I_D = 10\text{A}$	-	7.6	9.9	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance		-	1480	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 10\text{V}, f = 1\text{MHz}$	-	170	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	146	-	pF
$Q_g$	Total Gate Charge		-	16	-	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5\text{V}$	-	3	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	$V_{DS} = 10\text{V}, I_D = 4\text{A}$	-	5.5	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time		-	10	-	ns
$t_r$	Turn-On Rise Time	$V_{GS} = 4.5\text{V}, V_{DD} = 10\text{V}$	-	30	-	ns
$t_{d(off)}$	Turn-Off Delay Time	$I_D = 4\text{A}, R_{\text{GEN}} = 3\Omega$	-	40	-	ns
$t_f$	Turn-Off Fall Time		-	16	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current		-	-	50	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	200	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = 20\text{A}$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	7.5	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 5\text{A}, dI/dt = 100\text{A/us}$	-	1.6	-	nC

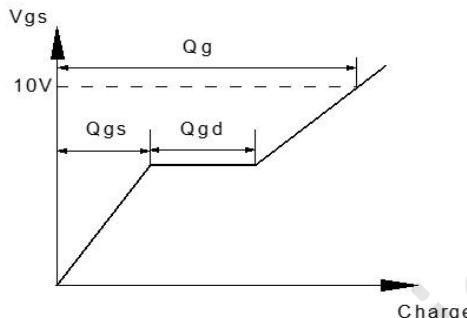
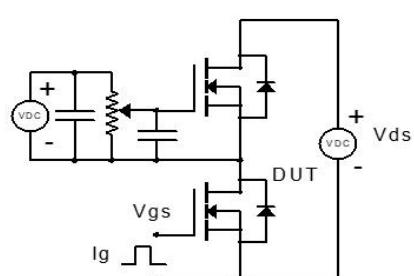
Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

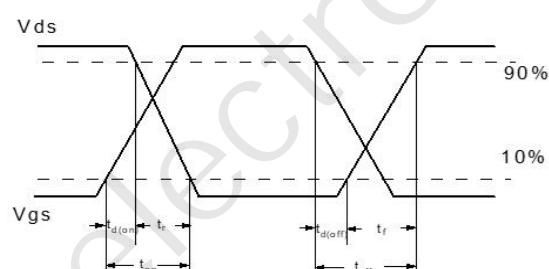
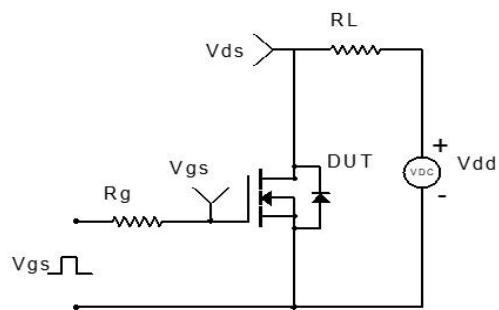
2.  $E_{AS}$  condition: Starting  $T_J=25^\circ\text{C}$ ,  $V_{DD}=10\text{V}$ ,  $V_G=10\text{V}$ ,  $R_G=250\text{ohm}$ ,  $L=0.5\text{mH}$ ,  $I_{AS}=13\text{A}$

3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

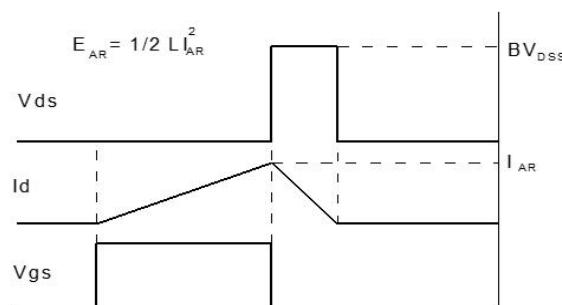
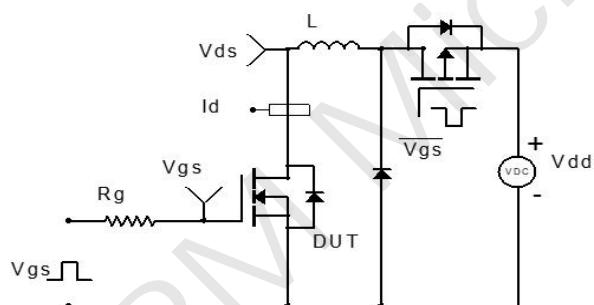
## Test Circuit



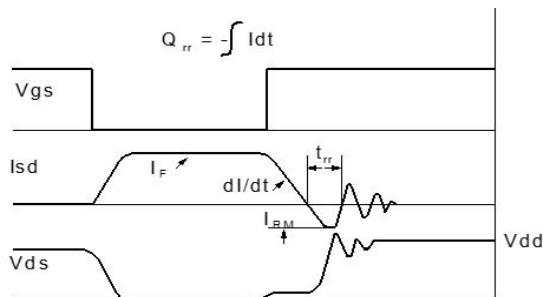
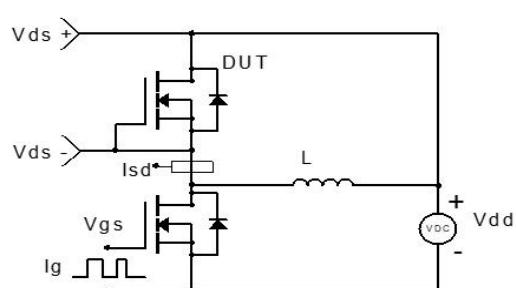
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

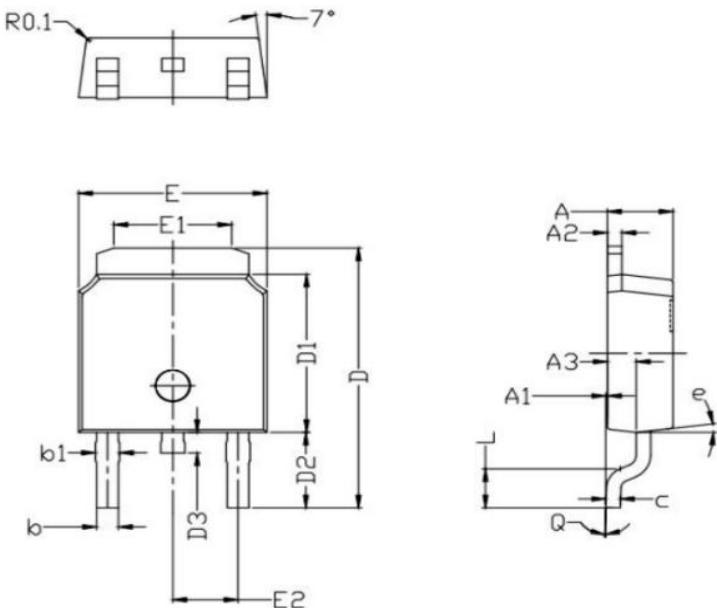


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(TO-252-3L)



COMMON DIMENSION(MM)			
PKG	TO-252-3L		
Symbol	MIN	MON	MAX
A	2.250	2.300	2.400
A1	0.010	0.060	0.150
A2	0.500	0.508	0.550
A3	0.960	1.010	1.060
b	0.740	0.760	0.800
b1	0.880	0.900	0.950
c	0.500	0.508	0.550
D	9.800	10.025	10.350
D1	6.050	6.100	6.180
D2	2.850	2.900	2.950
D3	0.700	0.800	2.900
E	6.550	6.600	6.700
E1	4.050	4.130	4.200
E2	2.250	2.286	2.300
L	1.400	1.500	1.600
e	7.000		
Q	0°	2°	5°

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